

Asymmetrical High Efficiency Two Channel Boost LED/OLED Driver

Features

- Integrated WLED and OLED driver
- 2.7V to 6V input voltage range
- Up to 85% typical efficiency even for different channel loads in terms of LED number, LED current and LED dropout
- Excellent 5 series x 1 parallel WLED drive capability (35 mA per channel)
- OLED channel with up to 18V/30 mA capability
- Independent current/voltage setting using external low power resistors for each channel (no ballast resistors)
- No external frequency compensation needed
- Low (<1%) LED output ripple voltage and current
- Input undervoltage lockout and output over voltage protection
- 1 MHz fixed switching frequency (0.5 MHz option available)
- Uses small inductor and ceramic capacitors
- Integrated 0.3 Ω internal power switch
- Disconnects LEDs during shutdown
- Low Profile TDFN-10 package
- Optional RoHS compliant lead free package

Applications

- Drives white LED backlighting and OLED
- Cellar phones
- Digital Cameras
- PDA, GPS, MP3 players
- Handheld devices

Product Description

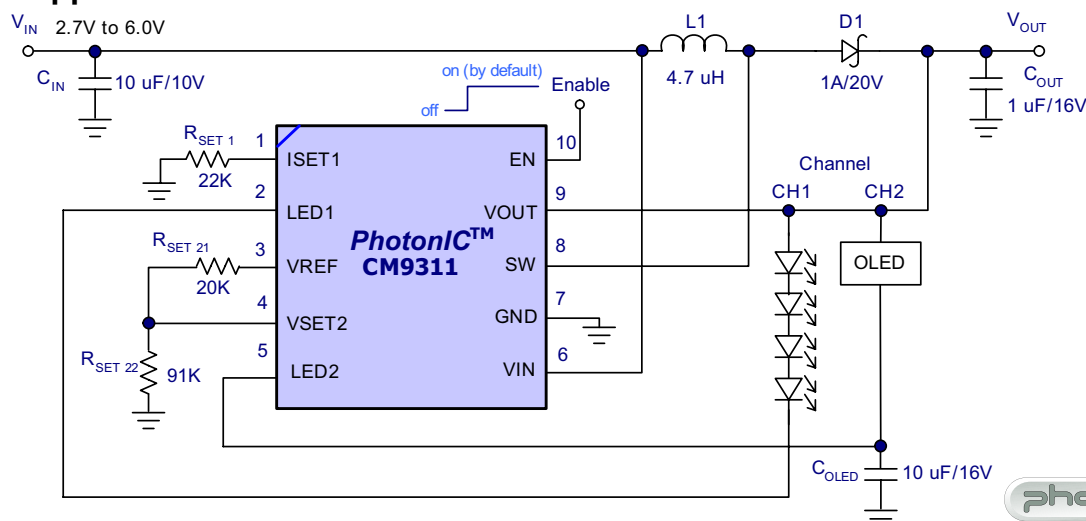
The CM9311 is a high frequency, two-channel inductor-based PWM boost regulator specifically designed for constant current white LED and constant voltage OLED drive applications. With a maximum 19V/100mA output capability, the circuit can drive up to 5 WLEDs (5 series x 1 parallel) and one OLED, allowing up to 35mA per channel. With an input voltage range from 2.7V to 6.0V, it can operate from a single cell Li-Ion battery.

The proprietary *FlexBoost*[™] architecture (patent pending) provides high efficiency (typical 85%) for a wide input voltage range, even for different channel loads in term of LED number, LED current and LED type. The maximum LED current and OLED voltage for each channel is independently programmed with external low-power resistors (no ballast resistors needed).

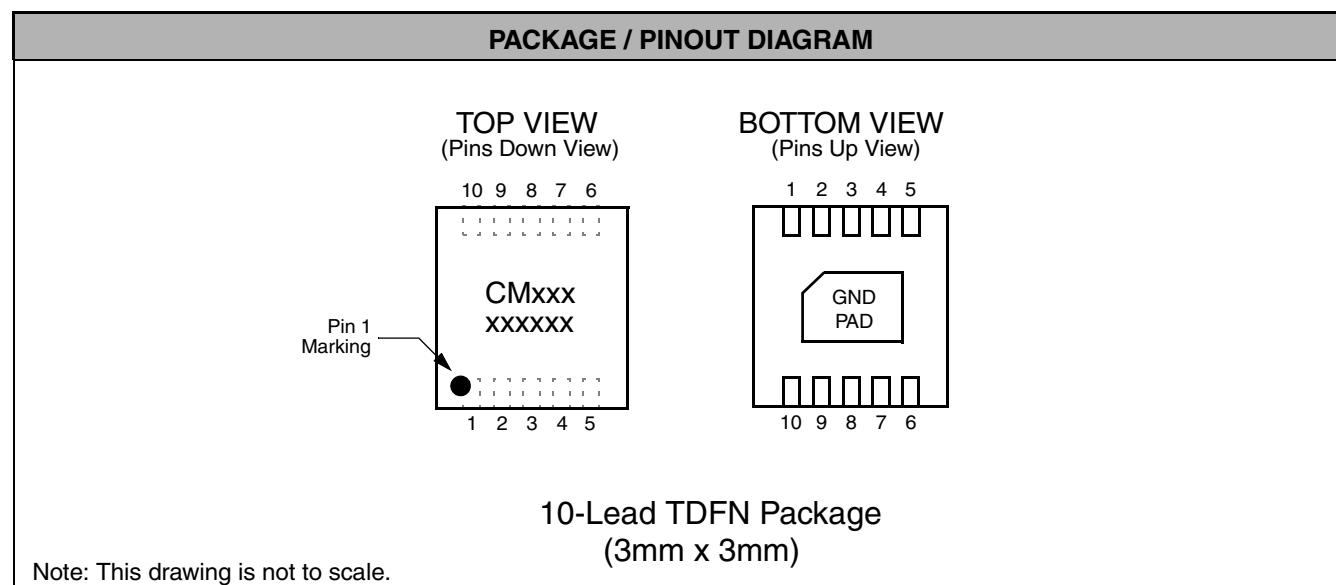
A 1 MHz constant frequency PWM saves board space, allowing small, low-cost external components, and permitting designers to avoid sensitive IF bands in RF applications. The output over-voltage protection circuit prevents damage in the case of a high impedance output (e.g. faulty LED). The controlled current limit circuit prevents large inductor current spikes, even at start-up. To avoid possible leakage currents, the EN control pin disconnects the LEDs from ground during shutdown.

The CM9311 is available in a compact TDFN-10 package. It can operate over the industrial temperature range of -40°C to 85°C.

Typical Application



Package Pinout



Ordering Information

| PART NUMBERING INFORMATION | | | |
|----------------------------|---------|-----------------------------------|--------------|
| Pins | Package | Lead Free Finish | |
| | | Ordering Part Number ¹ | Part Marking |
| 10 | TDFN | CM9311-01DE | |

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

Specifications

| ABSOLUTE MAXIMUM RATINGS | | |
|-----------------------------------|---------------------|-------|
| PARAMETER | RATING | UNITS |
| ESD Protection (HBM) | ± 2 | kV |
| VIN to GND | [GND - 0.3] to +6.0 | V |
| Pin Voltages | | |
| V _{OUT} , SW to GND | 20 | V |
| LED1, LED2, to GND | 20 | V |
| ISET1, VSET2, VREF, EN to GND | [GND - 0.3] to +5.0 | V |
| Storage Temperature Range | -65 to +150 | °C |
| Operating Temperature Range | -40 to +85 | °C |
| Lead Temperature (Soldering, 10s) | 300 | °C |

Specifications (cont'd)

| ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE 1) | | | | | | |
|---|-----------------------------------|---|----------|------------------------|-------|-----------|
| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
| $V_{IN} = 3.6V$; $C_{IN} = 10\mu F$, $C_{OUT} = 1\mu F$, $C_{OLED} = 1\mu F$, $L_1 = 4.7\mu H$, interleave mode , $T_A = 25^\circ C$ (unless otherwise specified) | | | | | | |
| V_{IN} | Input Voltage Range | | 2.7 | | 6.0 | V |
| I_Q | Quiescent Current | $I_{LED} < 0.6mA$ (each channel), non-switching | | 1.2 | 2.0 | mA |
| V_{UVLO} | Undervoltage Lockout | V_{IN} Rising | 2.0 | 2.2 | 2.4 | V |
| V_{OVP} | Output Overvoltage Protection | V_{OUT} Rising | 19.0 | 19.5 | 20.0 | V |
| I_{SD} | Shutdown Current | $V_{EN} = 0V$ | | 10 | 15 | μA |
| V_{EN} | Device Enable Threshold | Device ON (by default) Device OFF | 1.0 | | 0.2 | V V |
| Channel 1 (WLED) | | | | | | |
| I_{LED1} | LED Current (Note 1) | $V_{IN} = 3.0V$ to $6.0V$, $R_{SET1}(k\Omega)$ 4 WLED | 2 | $\frac{450}{R_{SET1}}$ | 35 | mA |
| | Number of WLEDs (Note 2) | $V_{IN} = 2.7V$ to $6.0V$ | 1 | | 5 | |
| V_{LED1} | Voltage on LED1 Pin | Standard load (Note 3) | | 0.80 | | V |
| Channel 2 (OLED) | | | | | | |
| V_{OLED} | OLED Voltage (Note 4) | $V_{IN} = 2.7V$ to $6.0V$ | 8 | $20 \times V_{VSET2}$ | 18 | V |
| I_{OLED} | OLED Current Range | | 2 | | 30 | mA |
| $\Delta V_{OLED} / V_{OLED}$ | OLED Regulation | $V_{IN} = 3.0V$ to $6.0V$, $I_{OLED} = 5mA$ to $20mA$ | | 5 | | % |
| $V_{OLEDacc}$ | OLED Voltage Accuracy | 1% divider resistors | | 3 | | % |
| V_{REF} | Reference Voltage | $T_A = 25^\circ C$ to $85^\circ C$ | 1.180 | 1.220 | 1.260 | V |
| I_{REF} | V_{REF} Divider Current | (Recommended) | 10 | 20 | 50 | μA |
| Boost Circuit (Note 3) | | | | | | |
| $\Delta I_{LED} / I_{LED} \cdot \Delta V_{IN}$ | Line Regulation | $V_{IN} = 3.0V$ to $6.0V$ Each Channel | | 1 | | %/V |
| I_{OUT} | Boost Output Current | $V_{IN} = 2.7V$ to $6.0V$ | 100 | | | mA |
| V_{OUT} | Boost Output Voltage | Standard Load (Note 3) | V_{IN} | | 20 | V |
| V_{OUTR} | Output Voltage Ripple | Standard Load (Note 3) | | 50 | | mVpp |
| D | Duty Cycle Range | $V_{IN} = 2.7V$ to $6.0V$, $I_{LED} = 2mA$ to $I_{LED MAX}$ | 5 | | 95 | % |
| $R_{DS(on)}$ | MOSFET ON Resistance | $I_{SW} = 0.8A$, $V_{GS} = 15V$ | | 300 | 500 | $m\Omega$ |
| Eff | Efficiency | Standard Load (Note 3) | | 85 | | % |
| I_{SW} | Switch Peak Current | Standard Load (Note 3) | | 0.5 | | A |
| P_{IN} | Input Power | $I_{LED 1,2} = 20mA$, 4WLED+OLED | | 770 | | mW |
| Control | | | | | | |
| $I_{LED acc}$ | Channel Current Matching (Note 5) | 1% R_{SET} Accuracy, Each Channel | | 3 | | % |
| I_{LEDR} | LED Current Ripple | Standard Load (Note 3) | | 0.2 | | mApp |
| I_{LEDNL} | No-Load Mode (Note 5) | All Channels | 0 | | 0.6 | mA |

Specifications (cont'd)

ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE 1)

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
|--------|---------------------|--------------------------------|-----|-----|-----|-------|
| fs | Switching Frequency | V _{IN} = 2.7V to 6.0V | 0.8 | 1.0 | 1.2 | MHz |

Note 1: I_{LED} is the average PWM current through the LED string with internal 2/3 duty cycle and a 6 ms period. The following formula must be used to calculate the LED current:

$$I_{LED(mA)} = \frac{450}{R_{SET(k\Omega)}}$$

Note 2: For lower LED forward voltage the number of LEDs can be increased up to the maximum output voltage limit.

Note 3: Standard Load is a 4 series x 2 parallel WLEDs configured for I_{LED1} = 20 mA (R_{SET1} = 22 kΩ) and one OLED channel (CH2) which drives V_{OLED}=12V and I_{OLED}=20mA.

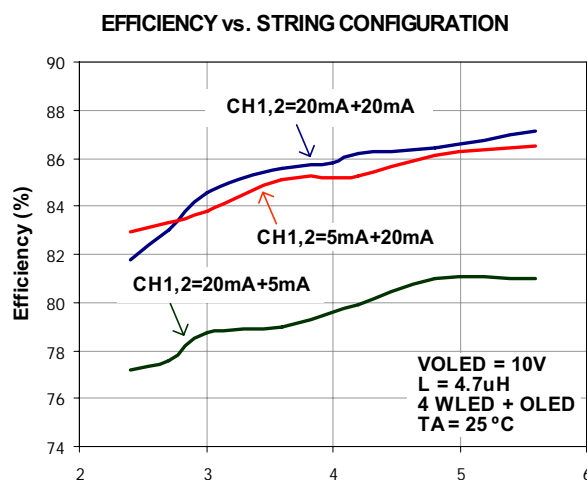
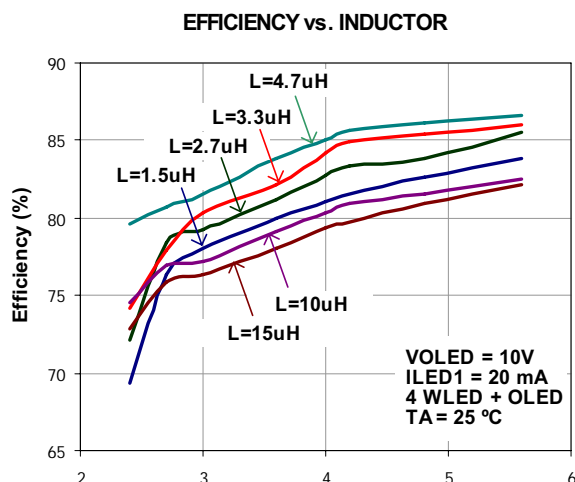
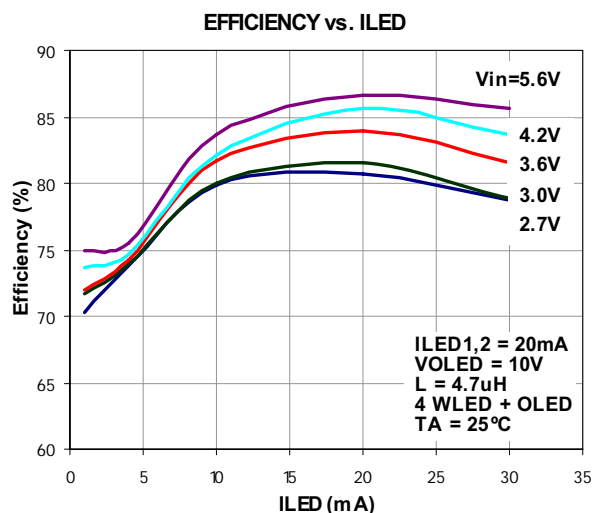
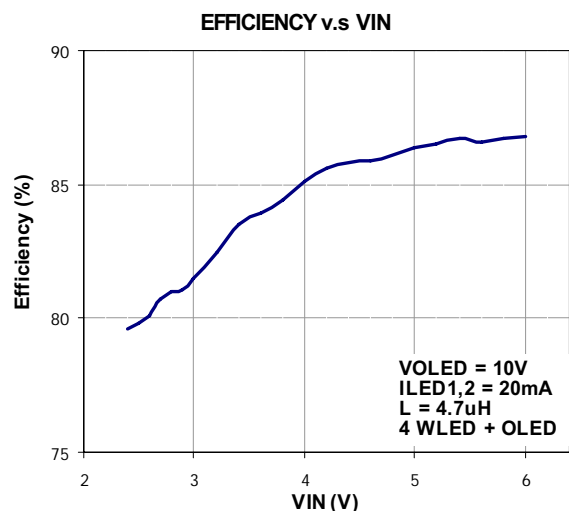
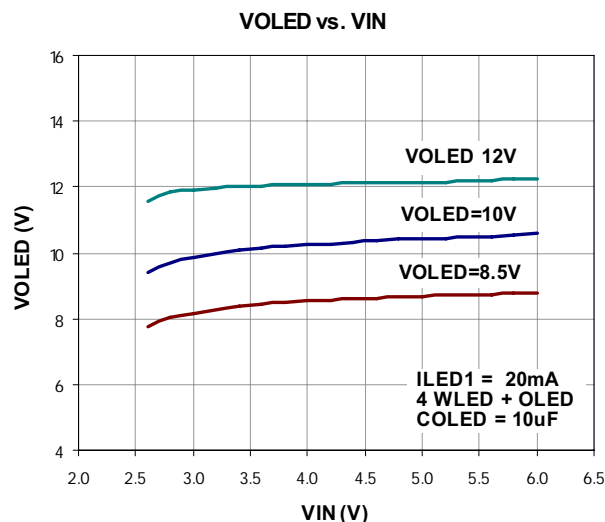
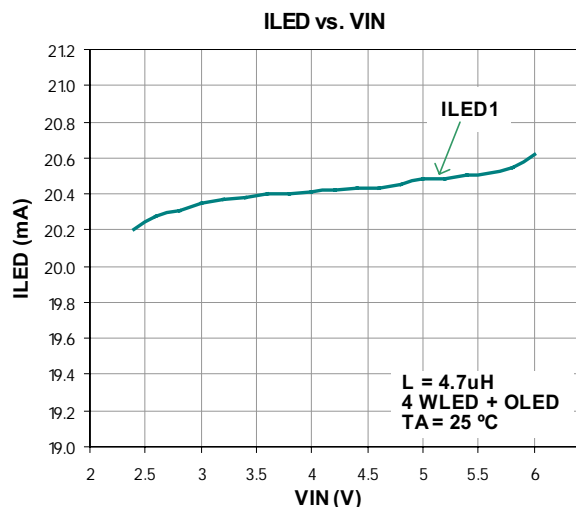
Note 4: V_{VSET2}, the voltage on VSET2 pin should be maintained in the 0.4V - 1.0V range. The following formulas are related to OLED channel settings:

$$V_{OLED} = V_{OUT} - V_{LED2} \quad , \quad V_{OLED} = 20 \times V_{SET2} \quad , \quad V_{VSET2} = \frac{R_{SET22}}{R_{SET21} + R_{SET22}} \times V_{REF}$$

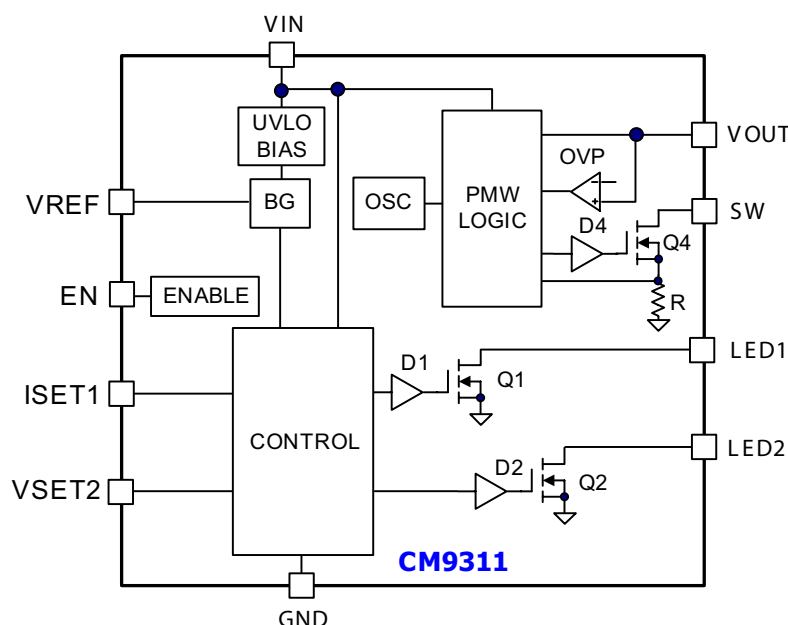
Note 5: [I_{LED(set)} - I_{LED(effective)}]/I_{LED(set)} for each channel.

Note 6: A I_{LED} value below 0.6 mA for each channel set the circuit in no-load mode; all channels and MOSFET switch are in shut-down and DC circuit current consumption is limited to 1 mA (see quiescent current).

Typical Performance Curves



Functional Block Diagram



Pin Descriptions

| PIN DESCRIPTIONS | | |
|------------------|-------------------|---|
| LEAD(s) | NAME | DESCRIPTION |
| 1 | IS _{ET1} | Channel 1 LED current set pin. Between this pin and GND connect the R _{SET1} resistor, calculated as follows: $R_{SET1(k\Omega)} = \frac{450}{I_{LED1(mA)}}$ where I _{LED1} is the DC LED current in channel 1. |
| 2 | LED1 | Pin to cathode of channel 1 LED string. |
| 3 | VREF | Reference voltage output pin, used to bias VSET2 node. |
| 4 | VSET2 | The voltage on this pin sets the VOLED as follows: $V_{OLED} = 20 \times V_{SET2}$ |
| 5 | LED2 | Pin to cathode of channel 2 LED string. |
| 6 | VIN | Input supply voltage pin. Bypass with a 10μF or larger ceramic capacitor to ground. |
| 7 | GND | Ground terminal pin. |
| 8 | SW | Switching node. Internally connected to the drain of the integrated switch. |
| 9 | VOUT | Output voltage pin, which connects to the anodes of all LEDs. Bypass with a 1.0μF or greater ceramic capacitor to ground for low output ripple voltage. |
| 10 | EN | Enable pin. The circuit is ON when V _{EN} is above 1.0V. The circuit is OFF when V _{EN} is below 0.2V. Active High (ON) by default. |
| EPad | GND | Ground; backside exposed pad. |

Application Information

The CM9311 is a high efficiency, magnetic switch-mode converter with current and voltage regulation driver ideally suited for driving white LEDs and OLED in Li-ion powered portable devices. The CM9311 is an asynchronous boost converter uses a low-resistance internal NMOS to drive small external inductor and Schottky diode. The CM9311 is the perfect converter for portable applications such as cellular phones, digital still cameras, PDAs and any application where small space, compact overall size and low system cost are critical.

With a maximum 19V/100mA output capability, the circuit can drive up to 5 WLEDs (4 series x 1 parallel) and one OLED device, allowing up to 35 mA per channel. It includes a switch and an internally compensated loop for regulating the current into the LEDs. The CM9311 delivers a constant current to series-connected LEDs and a constant voltage to OLED, ensuring uniform brightness and color purity regardless of any LED forward voltage variations.

The proprietary design architecture allows asymmetrical loading on each channel and maintains high efficiency (typ 85%) at low V_{IN} resulting in longer battery life, and cool, reliable operation when an adapter is supplying high V_{IN} . The maximum LED current or OLED voltage is independently programmed with external low power resistors avoiding ballast resistors.

An 1MHz constant frequency PWM scheme saves board space with the use of small, low cost external components, allowing designers to avoid sensitive IF bands in RF applications. The circuit operates with low value inductors and low value output ceramic capacitors keeping voltage and current ripple in the 1% range.

The output over-voltage protection circuit prevents damage in the case of high impedance output (e.g. faulty LED). The controlled current limit circuit limit prevents large inductor current spikes, even at start-up. To avoid possible leakage currents the EN control pin disconnects the LEDs from ground during shutdown.

CM9311 Operation

When a voltage that exceeds the undervoltage lockout threshold (UVLO) is applied to the VIN pin, the CM9311 initiates a softstart which limits the inrush current while the output capacitors are charged. Following softstart, the CM9311's internal NMOS drives an exter-

nal inductor and Schottky diode delivers the inductor's stored energy to the load.

Setting the LED Current

The output current for channel 1 (up to 35 mA) is set by the value of its R_{SET} resistor, located between the ISET1 pin and GND, according to the equations:

$$R_{SET(k\Omega)} = \frac{450}{I_{LED(mA)}}$$

Setting the OLED Voltage

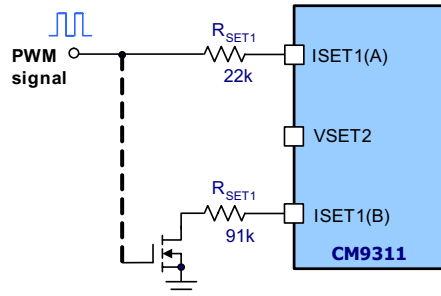
The output voltage for the OLED is the difference between V_{OUT} and the voltage at I_{LED2} pin. The voltage is programmed using the voltage divider R22 and R21, according to the equation:

$$V_{OLED} = 20 \times V_{SET2}$$

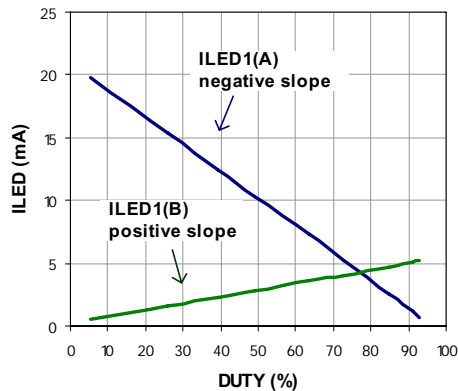
PWM Brightness Control

The brightness WLEDs level can be continuously controlled for each channel using a PWM signal in 1-50 KHz range (recommended value is 10 kHz). As an example the PWM signal can be applied directly through R_{SET} resistor for negative slope or by using a switch transistor for positive slope. See [Figure 1](#) for different brightness control methods and results. Method A means negative slop and Method B means positive slope.

Application Information (cont'd)



(a) Schematic



(b) Brightness curves

Figure 1. Brightness Control Using Different Methods

Inductor Selection

The inductor is used to store energy in a boost converter. The amount of energy stored in the inductor and transferred to the load is controlled by the PWM. The inductor is operated in the discontinuous conduction mode, and to assume proper operation, the inductor value must be limited to a maximum value.

An inductor with low series resistance (DCR) decreases power losses and increases efficiency. The core material should be capable of operating at 1 MHz with minimal core losses. An inductance of 4.7μH is optimum for most applications, but low DCR inductor values in 1.5–15μH range are also recommended for high efficiency applications.

To ensure proper operation of the current regulator over a wide range of conditions, the inductor should be

selected based on the required load power and the minimum input voltage. The saturation current rating should be chosen well above the steady state peak inductor current. At minimum V_{IN} and full duty cycle (worse case), this is approximately:

$$I_{PEAK} \cong \frac{V_{IN(MIN)} \times t_{ON}}{L} \cong \frac{3V \times 0.8 \times \frac{1}{1MHz}}{4.7\mu H} \cong 0.5A$$

Diode Selection

The low forward voltage and fast switching time make Schottky diodes the choice for high efficiency operation. Make sure the diode has a reverse voltage rating greater than the maximum output voltage. The diode conducts only when the power switch is on, so a peak current rating above 1A should be sufficient for a typical design.

Capacitor Selection

For proper performance, use surface-mount, low ESR ceramic capacitors for C_{IN} and C_{OUT} . X7R or X5R ceramic dielectric provides good stability over the operating temperature and voltage range.

In most LED applications, high frequency output ripple is not a concern because it will not cause intensity variations that are visible to the human eye.

For such applications, when low ripple is needed, a 22μF input capacitor and/or 2.2μF output capacitor are recommended.

| REF DES | DESCRIPTION | SOURCE |
|-----------|-------------------------------------|--|
| C_{IN} | Capacitor, 10μF, 10V, Ceramic, 1206 | Murata, GRM319R61A106KE19D Vishay, VJ1206G106KXQ |
| C_{OUT} | Capacitor, 1μF, 16V, Ceramic, 0805 | Murata, GRM188R61C105KA93D TDK, C2012X5R1C105K |
| L_1 | Inductor, 4.7μH, 1A, Low DCR | Coilcraft, LP06013-472ML TMP Electronics Co., SPC-03802-4R7 CHILISIN, SCD03015-4R7 SUMIDA, CDH3D13/S4R7 |
| D_1 | Schottky Diode, 1A, 20V, SMD | IR, MBR5120 CHENMKO, SSM5817S |

Input Filter

If CM9311 is more than 4" from main power supply point, use an input RC filter to avoid high ripple and input transients to the circuit input pin (see Figure 2).

Application Information (cont'd)

In this case, because of small input ripple, the efficiency is about 2% higher.

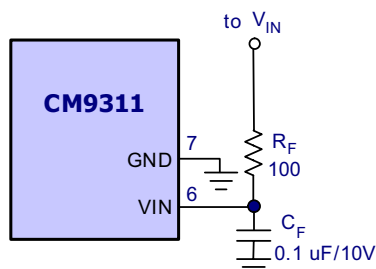


Figure 2. Input Filter Solution

Layout Guide

Components should be placed as close as practical to the IC to assure good performance. The input and output capacitors should be close, with minimum trace resistance and inductance. Reflected input ripple depends on the impedance of the VIN source, such as the PCB traces and the Li-ion battery, which has elevated impedance at higher frequencies. The input capacitor located near the converter input reduces this source impedance and ripple. Any ESR from the capacitor will result in steps and spikes in the ripple waveform, and possibly produce EMI.

Route any noise sensitive traces away from the switching power components. Place the inductor and diode as close as possible to the SW pin to prevent noise emissions.

The ground connections for RSET(1,21,22) resistors should be kept separate from the high power grounds and connect directly to the ground pin to assure accurate current and voltage settings. For better heat flow, connect all NC pins to GND plane. Also connect the thermal landing to the bottom ground plane with thermal vias.

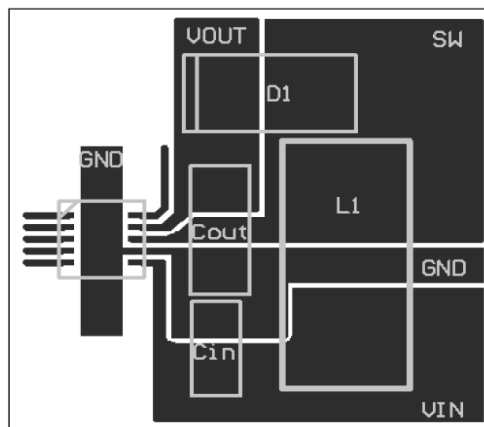


Figure 3. Example CM9311 PC Layout and Component Placement for Standard Application

Mechanical Details

TDFN-10 Mechanical Specifications

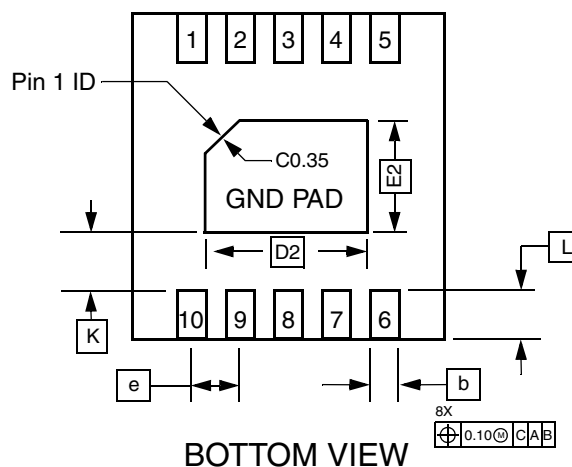
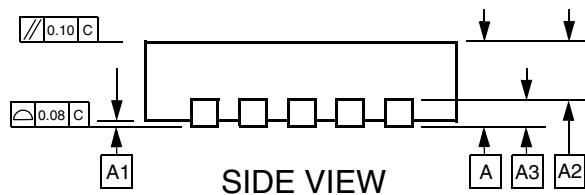
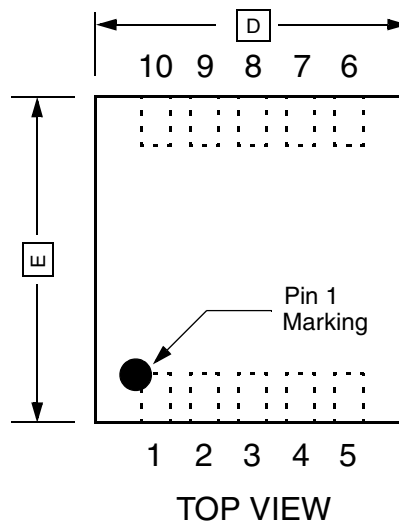
Dimensions for the CM9311 packaged in a 10-lead TDFN package are presented below.

For complete information on the TDFN-10, see the California Micro Devices TDFN Package Information document.

| PACKAGE DIMENSIONS | | | | | | |
|------------------------------------|-----------------------------------|------|------|--------|-------|-------|
| Package | TDFN | | | | | |
| JEDEC No. | MO-229 (Var. WEED-3) ¹ | | | | | |
| Leads | 10 | | | | | |
| Dim. | Millimeters | | | Inches | | |
| | Min | Nom | Max | Min | Nom | Max |
| A | 0.70 | 0.75 | 0.80 | 0.028 | 0.030 | 0.031 |
| A1 | 0.00 | 0.02 | 0.05 | 0.000 | 0.001 | 0.002 |
| A2 | 0.45 | 0.55 | 0.65 | 0.018 | 0.022 | 0.026 |
| A3 | | 0.20 | | | 0.008 | |
| b | 0.18 | 0.25 | 0.30 | 0.007 | 0.010 | 0.012 |
| D | | 3.00 | | | 0.118 | |
| D2 | 2.20 | 2.30 | 2.40 | 0.087 | 0.091 | 0.094 |
| E | | 3.00 | | | 0.118 | |
| E2 | 1.40 | 1.50 | 1.60 | 0.055 | 0.060 | 0.063 |
| e | | 0.50 | | | 0.020 | |
| K | 1.30 | 1.50 | 1.70 | 0.051 | 0.060 | 0.067 |
| L | 0.20 | 0.30 | 0.40 | 0.008 | 0.012 | 0.016 |
| # per tube | NA | | | | | |
| # per tape and reel | 3000 pieces | | | | | |
| Controlling dimension: millimeters | | | | | | |

¹This package is compliant with JEDEC standard MO-229, variation WEED-3 with exception of the "D2" and "E2" dimensions as called out in the table above.

Mechanical Package Diagrams



Package Dimensions for 10-Lead TDFN